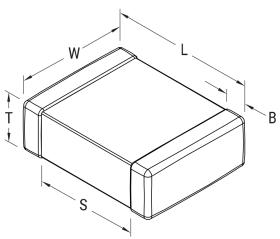


## C2225X124JCGACTU

Aliases (C2225X124JCGAC7800)

SMD Comm COG HV Flex, Ceramic, 0.12 uF, 5%, 500 VDC, COG, SMD, MLCC, FT-CAP, Ultra-Stable, 2225



Click here for the 3D model.

Dimensions	
Chip Size	2225
L	5.9mm +/-0.75mm
W	6.4mm +/-0.4mm
Т	2.5mm +/-0.20mm
S	3.2mm MIN
В	0.7mm +/-0.35mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	500

General Information		
Series	SMD Comm COG HV Flex	
Style	SMD Chip	
Description	SMD, MLCC, FT-CAP, Ultra-Stable	
Features	FT-CAP, Ultra-Stable	
RoHS	Yes	
Termination	Flexible Termination	
Marking	false	
AEC-Q200	No	
Typical Component Weight	390 mg	
Shelf Life	78 Weeks	
MSL	1	

Specifications	
Capacitance	0.12 uF
Measurement Condition	1 kHz 1.0Vrms
Capacitance Tolerance	5%
Voltage DC	500 VDC
Dielectric Withstanding Voltage	750 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1kHz 1.0Vrms
Dissipation Factor	0.1% 1 kHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	8.3333 GOhms

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